

**Advance Information**

MPC7410RXPNS/D  
Rev. 1, 10/2002

MPC7410 Part Number  
Specification for the  
MPC7410RXnnnPC Series



*Motorola Part  
Numbers Affected:*

*XPC7410RX400PC  
XPC7410RX450PC  
XPC7410RX500PC  
XPC7410RX550PC*

This document describes part number specific changes to recommended operating conditions and revised electrical specifications, as applicable, from those described in the general *MPC7410 Hardware Specifications* (order #: MPC7410EC/D).

Specifications provided in this Part Number Specification supersede those in the *MPC7410 Hardware Specifications*, for the part numbers listed in Table A only, specifications not addressed herein are unchanged. This document is frequently updated. Therefore, contact your Motorola sales office for the latest version.

Part numbers addressed in this document are listed in Table A. For more detailed ordering information see, Table 17.

**Table A. Part Numbers Addressed by this Data Sheet**

Motorola Part Number	Operating Conditions			Significant Differences from Hardware Specification
	CPU Frequency	Vdd	T <sub>J</sub> (°C)	
XPC7410RX400PC	400 MHz	2.0V±50mV	0 to 65	Modified Voltage & Temperature Specification to achieve 400Mhz frequency
XPC7410RX450PC	450 MHz	2.0V±50mV	0 to 65	Modified Voltage & Temperature Specification to achieve 450Mhz frequency
XPC7410RX500PC	500 MHz	2.0V±50mV	0 to 65	Modified Voltage & Temperature Specification to achieve 500Mhz frequency
XPC7410RX550PC	550 MHz	2.0V±50mV	0 to 65	Modified Voltage & Temperature Specification to achieve 550Mhz frequency

**Notes:**

The X prefix in a Motorola PowerPC part number designates a "Pilot Production Prototype" as defined by Motorola SOP 3-13. These are from a limited production volume of prototypes manufactured, tested and Q.A. inspected on a qualified technology to simulate normal production. These parts have only preliminary reliability and characterization data. Before pilot production prototypes may be shipped, written authorization from the customer must be on file in the applicable sales office acknowledging the qualification status and the fact that product changes may still occur while shipping pilot production prototypes.

## 1.2 Features

There are no changes to the features of the MPC7410 described in the *MPC7410 Hardware Specifications* (MPC7410EC/D).

### 1.4.1 DC Electrical Characteristics

Table 3 provides the recommended operating conditions for the MPC7410 part numbers described herein.

**Table 3. Recommended Operating Conditions**

Characteristic	Symbol	Recommended Value	Unit	
Core supply voltage	Vdd	2.0V±50mV	V	
PLL supply voltage	AVdd	2.0V±50mV	V	
L2 DLL supply voltage	L2AVdd	2.0V±50mV	V	
Processor bus supply voltage	BVSEL = 1 or BVSEL = HRESET	OVdd	2.5V±125mV	V
	BVSEL = GND	OVdd	1.8V±90mV	V
L2 bus supply voltage	L2VSEL = 1 or L2VSEL = HRESET	L2OVdd	2.5V±125mV	V
	L2VSEL = GND	L2OVdd	1.8V±90mV	V

**Table 3. Recommended Operating Conditions (continued)**

Characteristic		Symbol	Recommended Value	Unit
Input voltage	Processor bus	$V_{in}$	GND to OVdd	V
	L2 Bus	$V_{in}$	GND to L2OVdd	V
	JTAG Signals	$V_{in}$	GND to OVdd	V
Die-junction temperature		$T_j$	0-65	°C

Note: These are the recommended and tested operating conditions. Proper device operation outside of these conditions is not guaranteed.

Table 6 provides the power consumption for the MPC7410 part at the frequencies described herein.

**Table 6. Power Consumption for MPC7410**

	Processor (CPU) Frequency	Processor (CPU) Frequency	Unit	Notes
	400Mhz	500Mhz		
Full-On Mode				
Typical	6	7	W	1, 3,
Maximum	12	14	W	1, 2, 4
Doze Mode				
Maximum	4	5	W	1, 2
Nap Mode				
Maximum	2.0	2.25	W	1, 2
Sleep Mode				
Maximum	2.0	2.25	W	1, 2
Sleep Mode—PLL and DLL Disabled				
Typical	0.5	0.5	W	1, 3
Maximum	2.0	2.0	W	1, 2

**Notes:**

1. These values apply for all valid processor bus and L2 bus ratios. The values do not include I/O Supply Power (OVdd and L2OVdd) or PLL/DLL supply power (AVdd and L2AVdd). OVdd and L2OVdd power is system dependent, but is typically <10% of Vdd power. Worst case power consumption for AVdd = 15 mW and L2AVdd = 15 mW.
2. Maximum power is measured at Vdd = 2.2V while running an entirely cache-resident, contrived sequence of instructions which keep the execution units, including AltiVec, maximally busy.
3. Typical power is an average value measured at Vdd = AVdd = L2AVdd = 2.15V, OVdd = L2OVdd = 2.5V in a system while running a codec application that is AltiVec intensive.
4. These values include the use of AltiVec. Without AltiVec operation, estimate a 25% decrease.

### 1.4.2.1 Clock AC Specifications

Table 7 provides the additional clock AC timing specifications described in this Part Number Specification. Refer to the *MPC7410 Hardware Specification* for the remaining frequencies.

**Table 7. Clock AC Timing Specifications**

At recommended operating conditions (See Table 3)

Characteristic	Symbol	400 MHz		450 MHz		500 MHz		550 MHz		Unit	Notes
		Min	Max	Min	Max	Min	Max	Min	Max		
Processor frequency	$f_{core}$	300	400	300	450	300	500	300	550	MHz	
VCO frequency	$f_{VCO}$	600	800	600	900	600	1000	600	1100	MHz	
SYSClk frequency	$f_{SYSClk}$	33	100	33	100	33	100	33	100	MHz	1
SYSClk cycle time	$t_{SYSClk}$	10	30	10	30	10	30	10	30	ns	
SYSClk rise and fall time	$t_{KR} & t_{KF}$	—	1.0	—	1.0	—	1.0	—	1.0	ns	2
		—	0.5	—	0.5	—	0.5	—	0.5	ns	3
SYSClk duty cycle measured at $OV_{dd}/2$	$t_{KHKL}/t_{SYSCLK}$	40	60	40	60	40	60	40	60	%	4
SYSClk jitter		—	$\pm 150$	—	$\pm 150$	—	$\pm 150$	—	$\pm 150$	ps	5
Internal PLL relock time		—	100	—	100	—	100	—	100	$\mu s$	6

**Note:**

See general hardware specification.

### 1.4.2.2 Processor Bus AC Specifications

Table 8 provides the processor bus AC timing specifications for the MPC7410 part described in this Part Number Specification.

**Table 8. Processor Bus AC Timing Specifications**

At  $V_{dd}=AV_{dd}=2.0V\pm 50mV$ ;  $0 \leq T_j \leq 65^\circ C$ ,  $OV_{dd} = 2.5V\pm 0.125V$  and  $OV_{dd} = 1.8V\pm 0.090V$ , 60X bus at 100MHz

Parameter	Symbol	400, 450, 500, 550 Mhz		Unit	Notes
		Min	Max		
Mode select input setup to $\overline{HRESET}$	$t_{MVRH}$	8	—	$t_{sysclk}$	2,3,4,5
$\overline{HRESET}$ to mode select input hold	$t_{MXRH}$	0	—	ns	2,3,5
Setup Times:				ns	10
Address/Transfer Attribute	$t_{AVKH}$	1.4	—		6
Transfer Start ( $\overline{TS}$ )	$t_{TSVKH}$	1.4	—		—
Data/Data Parity	$t_{DVKH}$	1.4	—		7
$\overline{ARTRY}/\overline{SHD0}/\overline{SHD1}$	$t_{ARVKH}$	1.4	—		—
All Other Inputs	$t_{IVKH}$	1.4	—		8
Input Hold Times:				ns	11
Address/Transfer Attribute	$t_{AXKH}$	0	—		6
Transfer Start ( $\overline{TS}$ )	$t_{TSXKH}$	0	—		—
Data/Data Parity	$t_{DXKH}$	0	—		7
$\overline{ARTRY}/\overline{SHD0}/\overline{SHD1}$	$t_{ARXKH}$	0	—		—
All Other Inputs	$t_{IXKH}$	0	—		8
Valid Times:				ns	12
Address/Transfer Attribute	$t_{KHAV}$	—	3.0		6
$\overline{TS}$ , $\overline{ABB}$ , $\overline{DBB}$	$t_{KHTSV}$	—	3.0		—
Data	$t_{KHDV}$	—	3.5		7
Data Parity	$t_{KHDPV}$	—	3.5		7
$\overline{ARTRY}/\overline{SHD0}/\overline{SHD1}$	$t_{KHARV}$	—	2.3		—
All Other Outputs	$t_{KHOV}$	—	3.0		9
Output Hold Times:				ns	13
Address/Transfer Attribute	$t_{KHAX}$	0.75	—		6
$\overline{TS}$ , $\overline{ABB}$ , $\overline{DBB}$	$t_{KHTSX}$	0.75	—		—
Data/Data Parity	$t_{KHDX}$	0.6	—		7
$\overline{ARTRY}/\overline{SHD0}/\overline{SHD1}$	$t_{KHARX}$	0.75	—		—
All Other Outputs	$t_{KHOX}$	0.75	—		9
SYSCLK to Output Enable	$t_{KHOE}$	0.5	—	ns	14
SYSCLK to Output High Impedance (all except $\overline{TS}$ , $\overline{ABB}/\overline{AMON}(0)$ , $\overline{ARTRY}/\overline{SHD}$ , $\overline{DBB}/\overline{DMON}(0)$ )	$t_{KHOZ}$	—	3.5	ns	15
SYSCLK to $\overline{TS}$ , $\overline{ABB}/\overline{AMON}(0)$ , $\overline{DBB}/\overline{DMON}(0)$ High Impedance after precharge	$t_{KHABPZ}$	—	1.0	$t_{sysclk}$	4,15, 16,17
Maximum Delay to $\overline{ARTRY}/\overline{SHD0}/\overline{SHD1}$ Precharge	$t_{KHARP}$	—	1	$t_{sysclk}$	4,17
SYSCLK to $\overline{ARTRY}/\overline{SHD0}/\overline{SHD1}$ High Impedance After Precharge	$t_{KHARPZ}$	—	2	$t_{sysclk}$	4,17

**Note:**

See general hardware specification.

### 1.4.2.3 L2 Clock AC Specifications

Table 9 provides the L2CLK Output AC Timing Specifications for the MPC7410 part described in this Part Number Specification

**Table 9. L2CLK Output AC Timing Specifications**

At recommended operating conditions (See Table 3)

Parameter	Symbol	400 MHz		450 MHz		500 MHz		550 MHz		Unit	Notes
		Min	Max	Min	Max	Min	Max	Min	Max		
L2CLK frequency	$f_{L2CLK}$	150	200	150	225	150	250	150	275	MHz	1
L2CLK cycle time	$t_{L2CLK}$	5	6.67	4.4	6.67	4	6.67	3.6	6.67	ns	
L2CLK duty cycle	$t_{CHCL}/t_{L2CLK}$	50		50		50		50		%	2
Internal DLL-relock time		640	—	640	—	640	—	640	—	L2CLK	4
DLL capture window			±200		±200		±200		±200	ns	5

**Note:**

See general hardware specification.

### 1.4.2.4 L2 Bus AC Specifications

Table 10 provides the L2 Bus Interface AC Timing Specifications for the frequencies described in this Part Number Specification.

**Table 10. L2 Bus Interface AC Timing Specifications**

At  $V_{dd}=AV_{dd}=L2AV_{dd}=2.05V\pm 50mV$ ;  $0 \leq T_j \leq 65^\circ C$ ,  $L2OV_{dd} = 2.5V\pm 0.125V$  and  $L2OV_{dd} = 1.8V\pm 0.090V$

Parameter	Symbol	400 MHz		450 MHz		500 MHz		550 MHz		Unit	Notes
		Min	Max	Min	Max	Min	Max	Min	Max		
L2SYNC_IN rise and fall time	$t_{L2CR}$ & $t_{L2CF}$	—	1.0	—	1.0	—	1.0	—	1.0	ns	1
Setup Times: Data and parity	$t_{DVL2CH}$	1.5	—	1.375	—	1.250	—	1.125	—	ns	2
Input Hold Times: Data and parity	$t_{DXL2CH}$	—	0.0	—	0.0	—	0.0	—	0.0	ns	2

**Table 10. L2 Bus Interface AC Timing Specifications (continued)**

At Vdd=AVdd=L2AVdd= 2.05V±50mV; 0 ≤ Tj ≤ 65°C, L2OVdd = 2.5V±0.125V and L2OVdd =1.8V±0.090V

Parameter	Symbol	400 MHz		450 MHz		500 MHz		550 MHz		Unit	Notes
		Min	Max	Min	Max	Min	Max	Min	Max		
Valid Times: All outputs when L2CR[14-15] = 00 All outputs when L2CR[14-15] = 01 All outputs when L2CR[14-15] = 10 All outputs when L2CR[14-15] = 11	t <sub>L2CHOV</sub>	-	2.5	-	2.375	-	2.25	-	2.05	ns	3,4
Output Hold Times All outputs when L2CR[14-15] = 00 All outputs when L2CR[14-15] = 01 All outputs when L2CR[14-15] = 10 All outputs when L2CR[14-15] = 11	t <sub>L2CHOX</sub>	0.6	-	0.55	-	0.5	-	0.45	-	ns	3
L2SYNC_IN to high impedance All outputs when L2CR[14-15] = 00 All outputs when L2CR[14-15] = 01 All outputs when L2CR[14-15] = 10 All outputs when L2CR[14-15] = 11	t <sub>L2CHOZ</sub>	-	2.0	-	2.0	-	2.0	-	2.0	ns	

**Note:**

See general hardware specification.

## 1.9 Document Revision History

Table Table 16. provides a revision history for this Part Number Specification.

**Table 16. Document Revision History**

Document Revision	Substantive Changes
Rev 0	Initial Release
Rev 1	Minor reformatting. Section 1.10.1 - added Table 17, Part Marking Nomenclature

## 1.10 Ordering Information

### 1.10.1 Part Numbers Addressed by this Specification

Table 17 provides the ordering information for the MPC7410 part described in this document.

Table 17. Part Marking Nomenclature

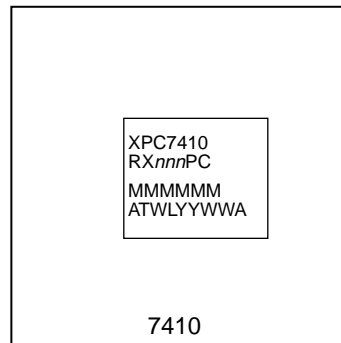
Product Code	Part Identifier	Package	Processor Frequency <sup>1</sup>	Application Modifier	Revision Level
XPC	7410	RX = CBGA	450 500 550	P: 2.0 V ± 50 mV 0 to 65 °C	C: 1.2; PVR = 800C 1102

**Notes:**

1. Processor core frequencies supported by parts addressed by this specification only. Parts addressed by other specifications may support other maximum core frequencies.
2. The X prefix in a Motorola PowerPC part number designates a “Pilot Production Prototype” as defined by Motorola SOP 3-13. These are from a limited production volume of prototypes manufactured, tested and Q.A. inspected on a qualified technology to simulate normal production. These parts have only preliminary reliability and characterization data. Before pilot production prototypes may be shipped, written authorization from the customer must be on file in the applicable sales office acknowledging the qualification status and the fact that product changes may still occur while shipping pilot production prototypes.

### 1.10.3 Part Marking

Parts are marked as the example shown in Figure 26.



**Notes:**

- nnn* is the speed grade of the part
- MMMMMM is the 6-digit mask number
- ATWLYYWWA is the traceability code
- CCCCC is the country of assembly (this space is left blank if parts are assembled in the United States)

**Figure 26. Motorola Part Marking for BGA Device**









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